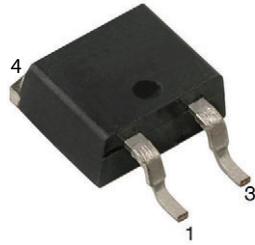
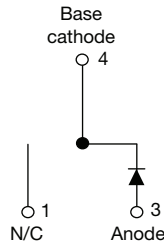


Hyperfast Rectifier, 30 A FRED Pt® G5


D²PAK 2L (TO-263AB 2L)


FEATURES

- Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off
- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Designed and qualified according JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | |
|--------------------------|------------------------|
| $I_{F(AV)}$ | 30 A |
| V_R | 1200 V |
| V_F at I_F at 125 °C | 2.1 V |
| t_{rr} | 26 ns |
| T_J max. | 175 °C |
| Package | D²PAK 2L (TO-263AB 2L) |
| Circuit configuration | Single |

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for high frequency converters, both soft switched / resonant.

Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

MECHANICAL DATA

Case: D²PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | |
|--|-------------------|---|-------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Repetitive peak reverse voltage | V_{RRM} | | 1200 | V |
| Average rectified forward current | $I_{F(AV)}$ | $T_C = 83\text{ °C}$, $D = 0.50$ | 30 | A |
| Non-repetitive peak surge current | I_{FSM} | $T_C = 83\text{ °C}$, $t_p = 10\text{ ms}$, sine wave | 190 | |
| Repetitive peak forward current | I_{FRM} | $T_C = 45\text{ °C}$, $D = 0.50$, $f = 20\text{ kHz}$ | 60 | |
| Operating junction and storage temperature | T_J , T_{Stg} | | -55 to +175 | °C |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified) | | | | | | |
|--|------------------|---|------|------|------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR} , V_R | $I_R = 100\text{ }\mu\text{A}$ | 1200 | - | - | V |
| Forward voltage | V_F | $I_F = 30\text{ A}$ | - | 2.6 | 3.3 | |
| | | $I_F = 30\text{ A}$, $T_J = 125\text{ °C}$ | - | 2.1 | - | |
| Reverse leakage current | I_R | $V_R = V_R$ rated | - | - | 50 | μA |
| | | $T_J = 125\text{ °C}$, $V_R = V_R$ rated | - | - | 500 | |
| Junction capacitance | C_T | $V_R = 200\text{ V}$ | - | 17 | - | pF |
| Series inductance | L_S | Measured to lead 5 mm from package body | - | 8 | - | nH |



| DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | | | | |
|---|-----------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Reverse recovery time | t_{rr} | $I_F = 1.0\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$ | - | 26 | - | ns |
| | | $T_J = 25\text{ }^\circ\text{C}$ | - | 100 | - | |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 150 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^\circ\text{C}$ | - | 12 | - | A |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 22 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 530 | - | nC |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 1650 | - | |
| Reverse recovery time | t_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 80 | - | ns |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 120 | - | |
| Peak recovery current | I_{RRM} | $T_J = 25\text{ }^\circ\text{C}$ | - | 22 | - | A |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 37 | - | |
| Reverse recovery charge | Q_{rr} | $T_J = 25\text{ }^\circ\text{C}$ | - | 900 | - | nC |
| | | $T_J = 125\text{ }^\circ\text{C}$ | - | 2400 | - | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-------------------|--|--------------|------|------------|---------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Thermal resistance, junction-to-case | R_{thJC} | | - | - | 1.1 | $^\circ\text{C}/\text{W}$ |
| Weight | | | - | 2.0 | - | g |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) |
| Maximum junction and storage temperature range | T_J , T_{Stg} | | -55 | - | 175 | $^\circ\text{C}$ |
| Marking device | | Case style D ² PAK 2L (TO-263AB 2L) | E5TX3012S | | | |

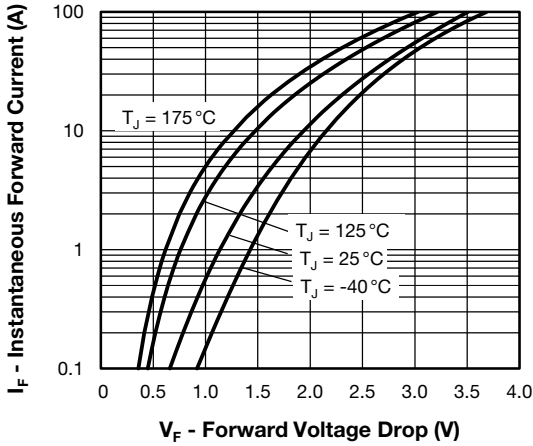


Fig. 1 - Typical Forward Voltage Drop Characteristics

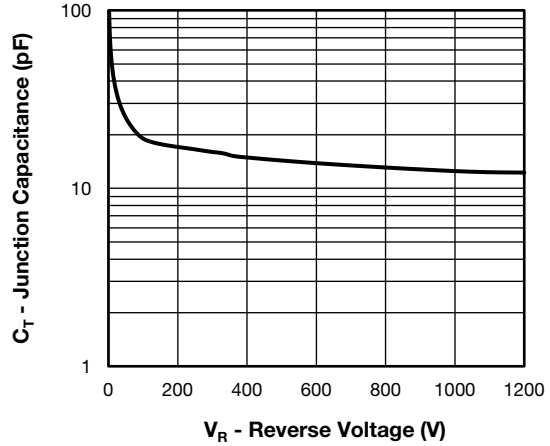


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

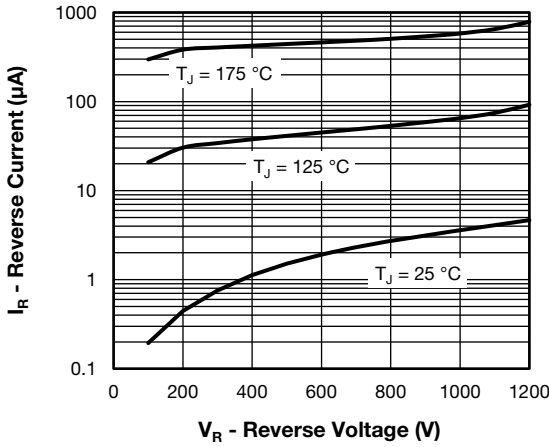


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

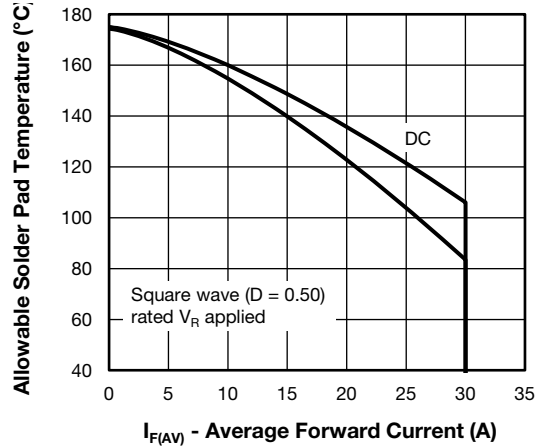


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

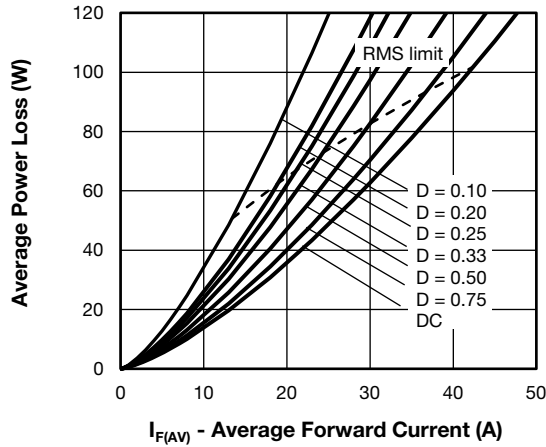


Fig. 5 - Typical Recovery Current vs. dI_F/dt

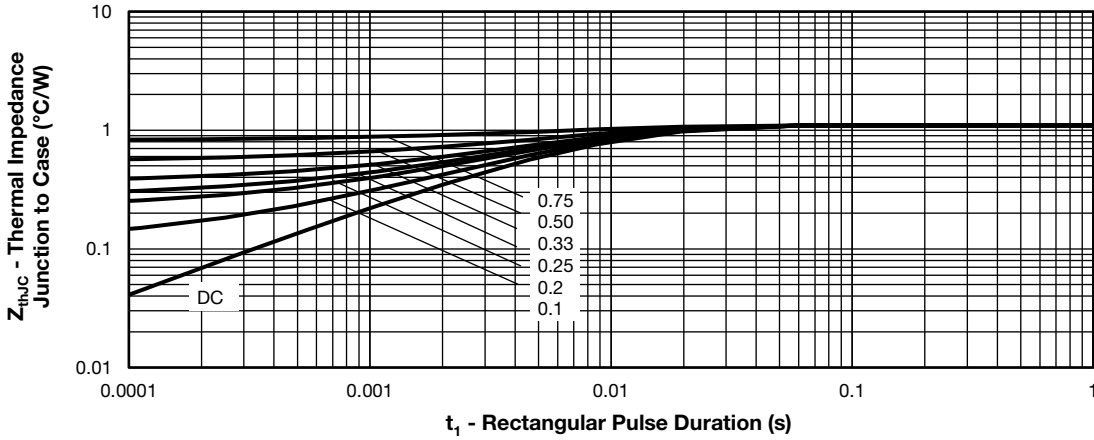


Fig. 6 - Thermal Impedance Z_{thJC} Characteristics

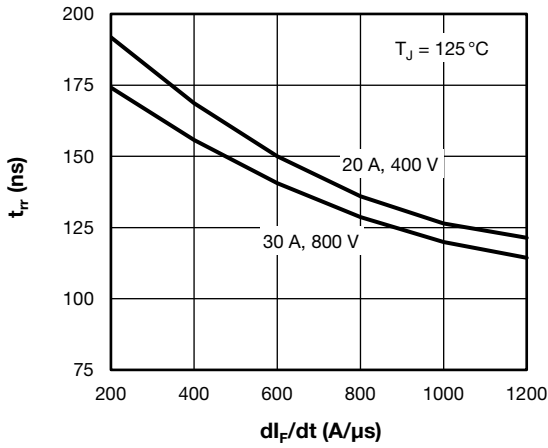


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

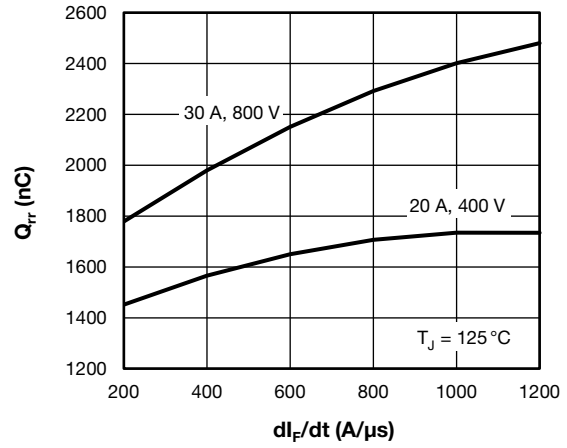


Fig. 8 - Typical Stored Charge vs. dI_F/dt

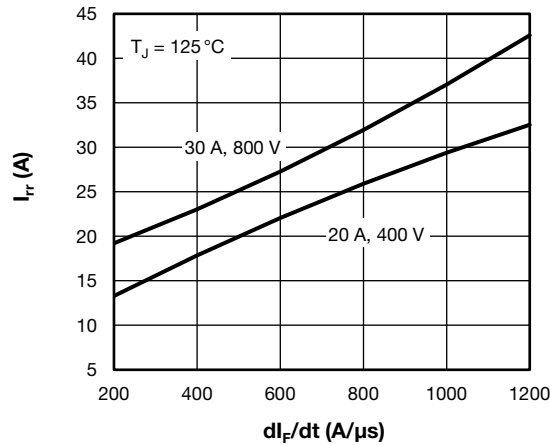


Fig. 9 - Typical Recovery Current vs. dI_F/dt

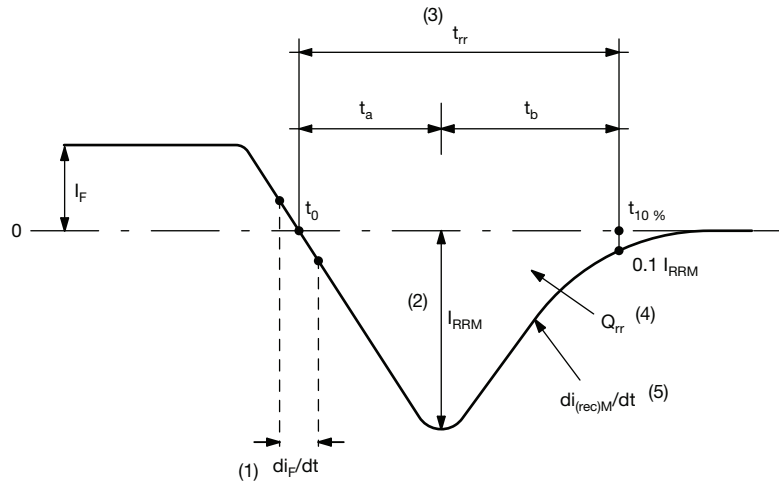


Fig. 10 - Reverse Recovery Waveform and Definitions

Notes

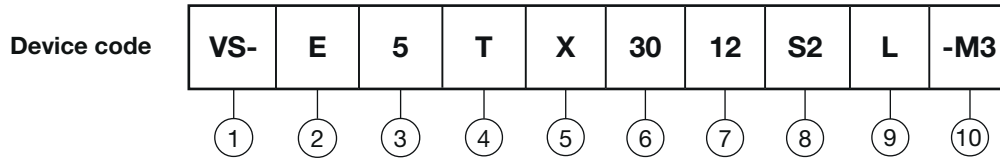
- (1) di_F/dt - rate of change of current through zero crossing
- (2) I_{RRM} - peak reverse recovery current
- (3) t_{rr} - reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, $0.1 I_{RRM}$
- (4) Q_{rr} - area under curve defined by t_0 and $t_{10\%}$

$$Q_{rr} = \int_{t_0}^{t_{10\%}} I(t) dt$$

- (5) $di_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - E = single diode
- 3** - 5 = FRED generation 5
- 4** - Package:
T = D²PAK (TO-262) package
- 5** - X = hyperfast recovery
- 6** - Current rating (30 = 30 A)
- 7** - Voltage rating (12 = 1200 V)
- 8** - S2 = true 2 pin D²PAK
- 9** - None = tube (50 pieces)
• L = tape and reel (left oriented, for D²PAK package)
If needed different orientation/packaging, please contact factory
- 10** - Environmental digit:
-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

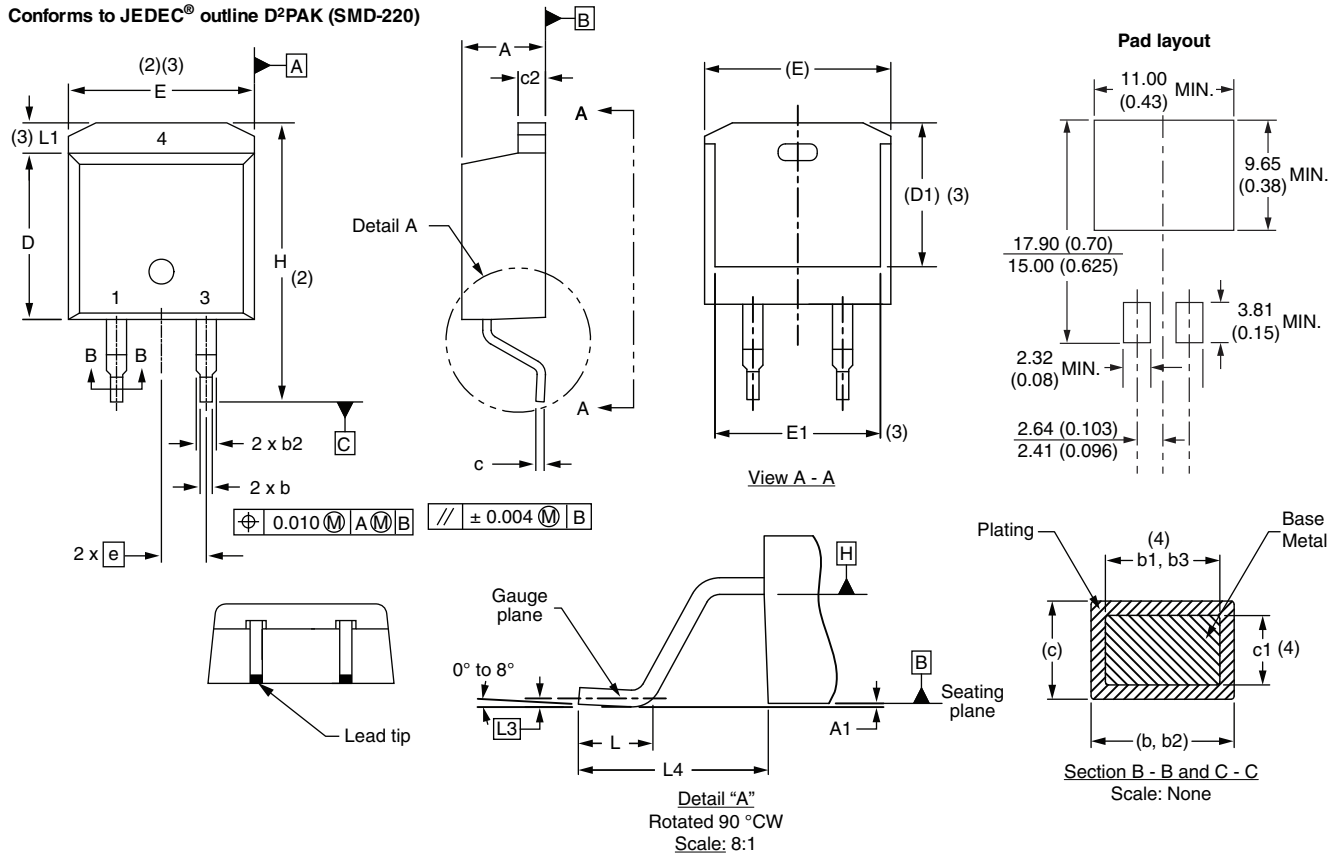
| ORDERING INFORMATION (Example) | | |
|--------------------------------|---------------|-----------------------|
| PREFERRED P/N | BASE QUANTITY | PACKAGING DESCRIPTION |
| VS-E5TX3012S2L-M3 | 800 | 13" diameter reel |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?96683 |
| Part marking information | www.vishay.com/doc?96693 |
| Packaging information | www.vishay.com/doc?95032 |
| SPIICE model | www.vishay.com/doc?97017 |

D²PAK 2L (TO-263AB 2L)

DIMENSIONS in millimeters and inches

Conforms to JEDEC[®] outline D²PAK (SMD-220)



| SYMBOL | MILLIMETERS | | INCHES | | NOTES | SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|--------|-------|-------|--------|-------------|-------|-----------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | | | MIN. | MAX. | MIN. | MAX. | |
| A | 4.06 | 4.83 | 0.160 | 0.190 | | D1 | 6.86 | 8.00 | 0.270 | 0.315 | 3 |
| A1 | 0.00 | 0.254 | 0.000 | 0.010 | | E | 9.65 | 10.67 | 0.380 | 0.420 | 2, 3 |
| b | 0.51 | 0.99 | 0.020 | 0.039 | | E1 | 7.90 | 8.80 | 0.311 | 0.346 | 3 |
| b1 | 0.51 | 0.89 | 0.020 | 0.035 | 4 | e | 2.54 BSC | | 0.100 BSC | | |
| b2 | 1.14 | 1.78 | 0.045 | 0.070 | | H | 14.61 | 15.88 | 0.575 | 0.625 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 | L | 1.78 | 2.79 | 0.070 | 0.110 | |
| c | 0.38 | 0.74 | 0.015 | 0.029 | | L1 | - | 1.65 | - | 0.066 | 3 |
| c1 | 0.38 | 0.58 | 0.015 | 0.023 | 4 | L3 | 0.25 BSC | | 0.010 BSC | | |
| c2 | 1.14 | 1.65 | 0.045 | 0.065 | | L4 | 4.78 | 5.28 | 0.188 | 0.208 | |
| D | 8.51 | 9.65 | 0.335 | 0.380 | 2 | | | | | | |

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC[®] outline TO-263AB



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.